

REV.	ECN NO.	REVISED	DATE

NOTE:

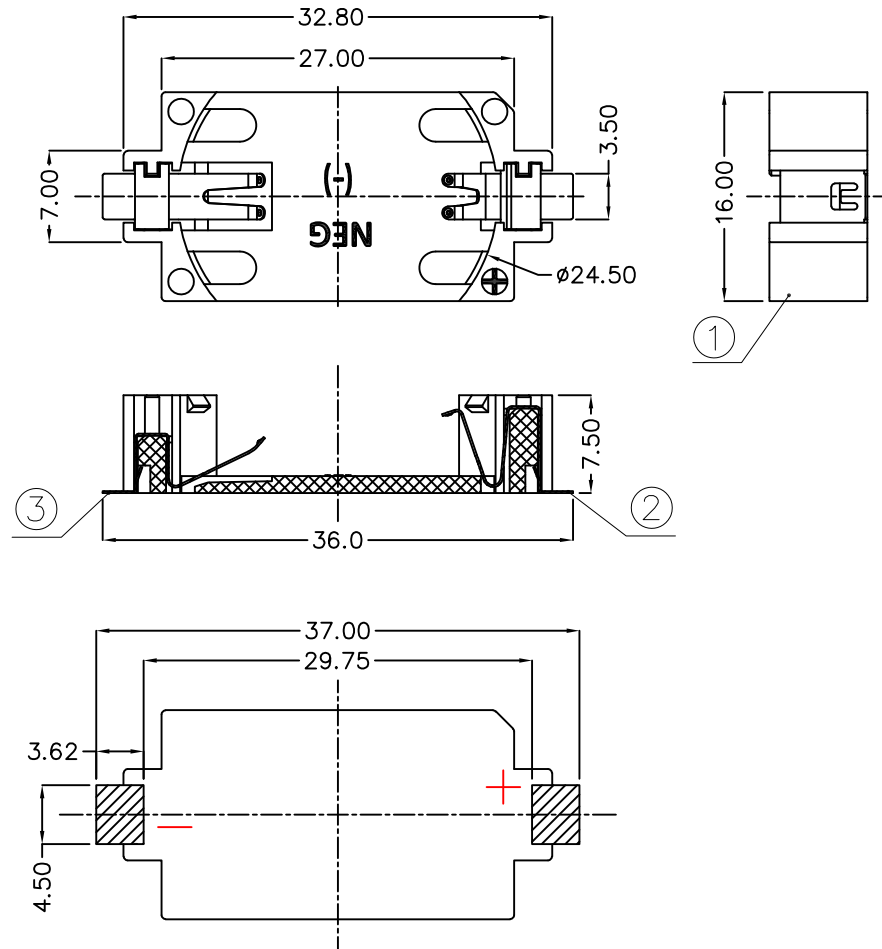
1.MATERIAL:

- a.HOUSING: LCP UL94V-0
b.CONTACT:PHOSPHOR BRONZE
(SURFACE PLATING: Au1u")

SEE ORDERING INFORMATION

2.ELECTRIC:

- a.CONTACT RESISTANCE: 30 MILLIOHMS MAX
b.INSULATION RESISTANCE: 100 MEGA OHMS MIN
c.DIELECTNIC VOLTAGE: 500V AC ONE SEC LEVEL
d.OPERATING TEMPERATURE: -25° C ~ +85° C



PCB Layout Diagram
Top View

3	TERMINAL(-)	1	PHOSPHOR BRONZE, T=0.15mm	Gold Plating and Ni Under-Plating
2	TERMINAL(+)	1	PHOSPHOR BRONZE, T=0.15mm	Gold Plating and Ni Under-Plating
1	HOUSE	1	LCP UL94 V-0	WHITE
NO.	PART NAME	Q'TY	MATERIAL	PLATING & COLOR

UNLESS OTHERWISE SPECIFIED TOLERANCES		Shenzhen Jiatel Hardware Electronics Co.,Ltd					
DECIMALS:	ANGLES:	DSND	YangFeng	DATE	2018-05-30	TITLE: CR2450, SMD AU	
X :±0.30	X :±1°	CHKD	ZhouRuicai	DATE	2018-05-30		
X.X :±0.25	X.X :±0.5°	APVD	XueShun Yong	DATE	2018-05-30	PART NO.: JT-BH2450-2	
X.XX :±0.20		WEIGHT:	SCALE:	SIZE:	A4	VIEW:	⊙ ⊞
X.XXX :±0.10		SHEET 1 OF 1	UNIT: mm	REV.:	A/0	OBJECT:	
				DRAW NO.:	CP-0138		